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(12) **United States Design Patent**
Lin

(10) **Patent No.:** **US D510,934 S**

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(54) **COMPUTER HOUSING**

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(**) **Term:** **14 Years**

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(51) **LOC (8) Cl.** **14-02**

(52) **U.S. Cl.** **D14/349**

(58) **Field of Search** D14/349-356;
D13/162, 184, 199; 312/223.1-223.3, 194;
360/99.01-99.12; 361/690-696; 369/34.01,
36.01

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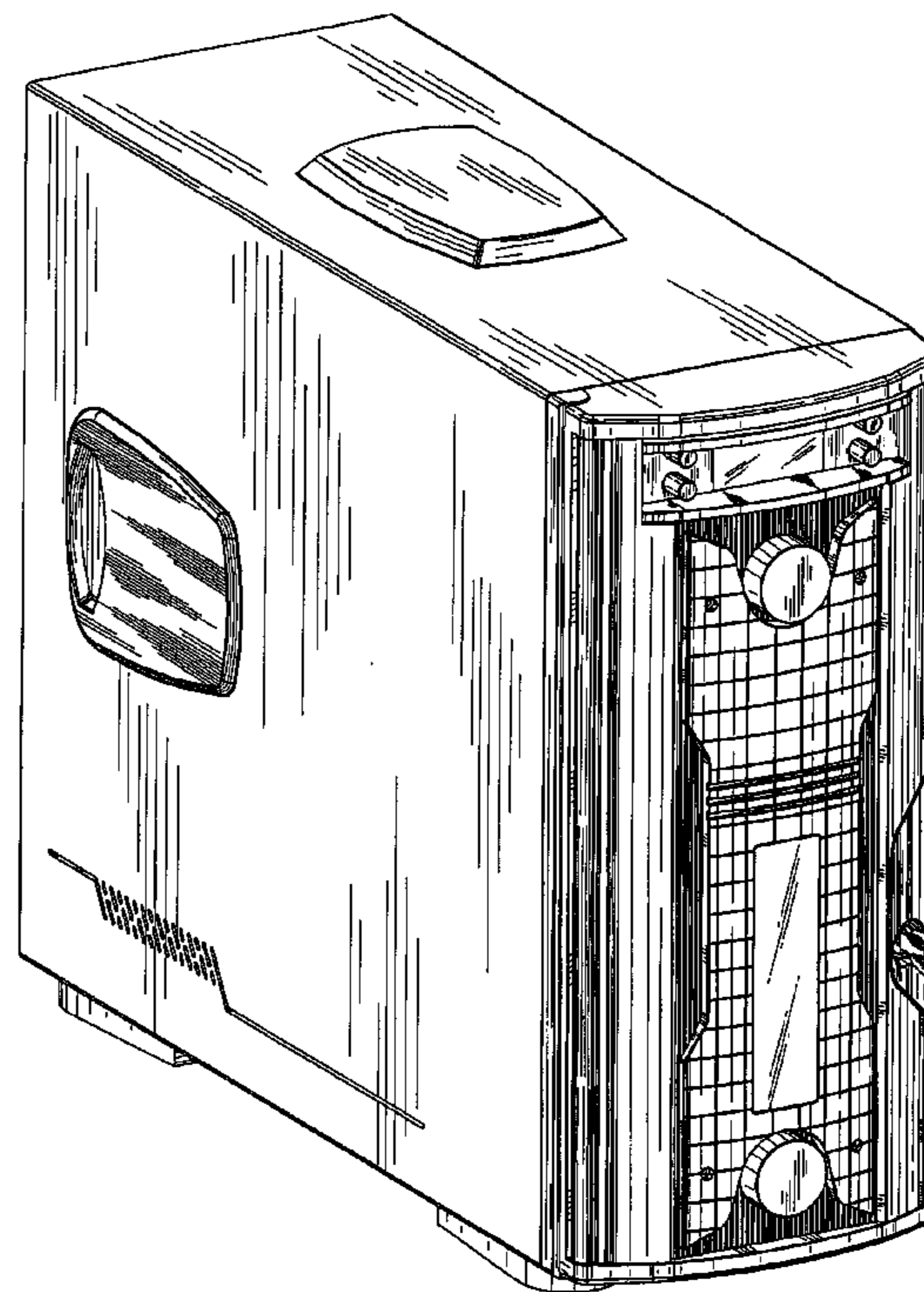
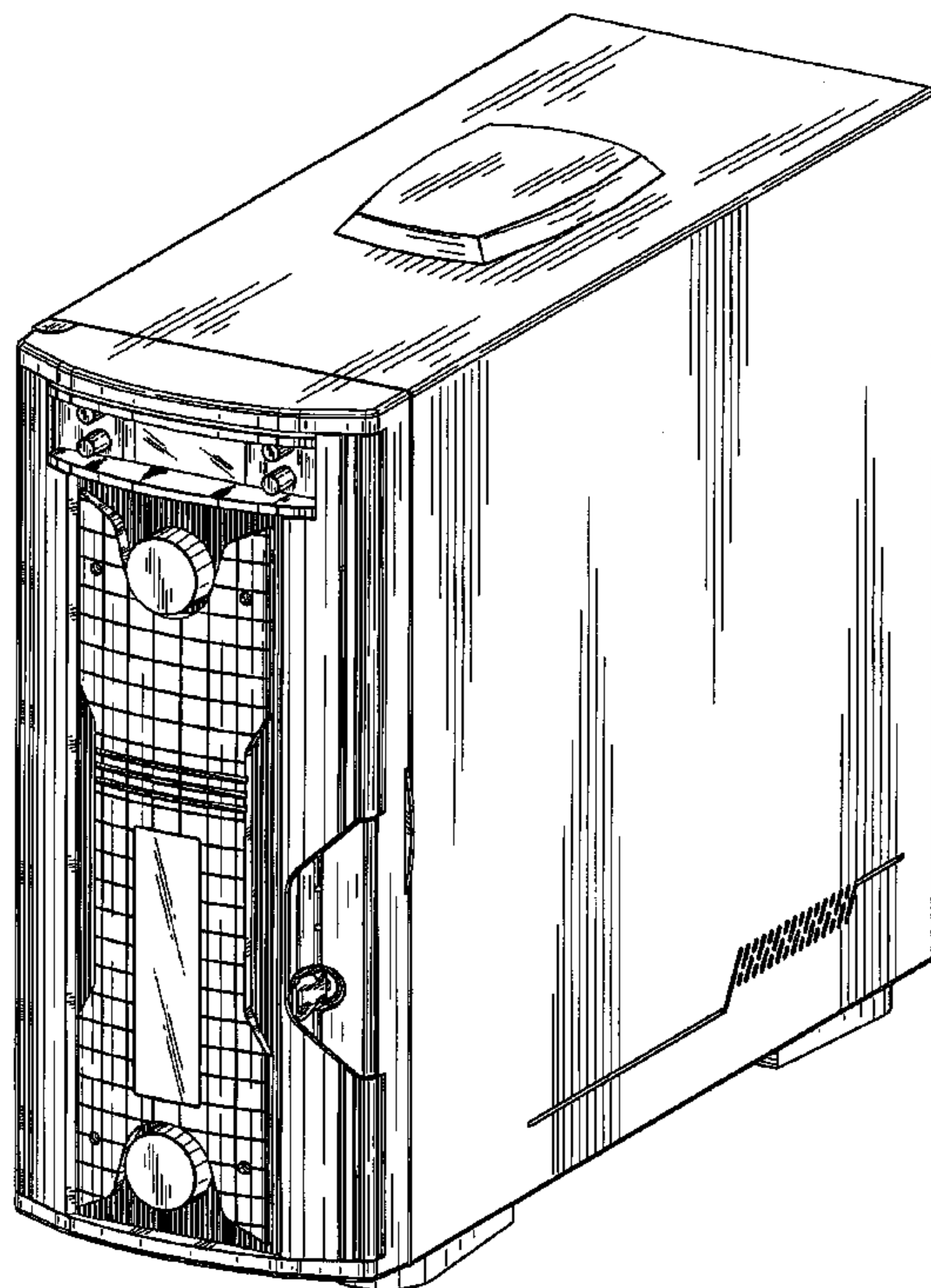
(57) **CLAIM**

The ornamental design for a computer housing, as shown and described.

DESCRIPTION

FIG. 1 is a top, front and right side perspective view of a computer housing showing my new design; FIG. 2 is a front elevational view thereof; FIG. 3 is a rear elevational view thereof; FIG. 4 is a left side elevational view thereof; FIG. 5 is a right side elevational view thereof; FIG. 6 is a top plan view thereof; FIG. 7 is a bottom plan view thereof; and, FIG. 8 is a top, front and left side perspective view thereof.

1 Claim, 8 Drawing Sheets



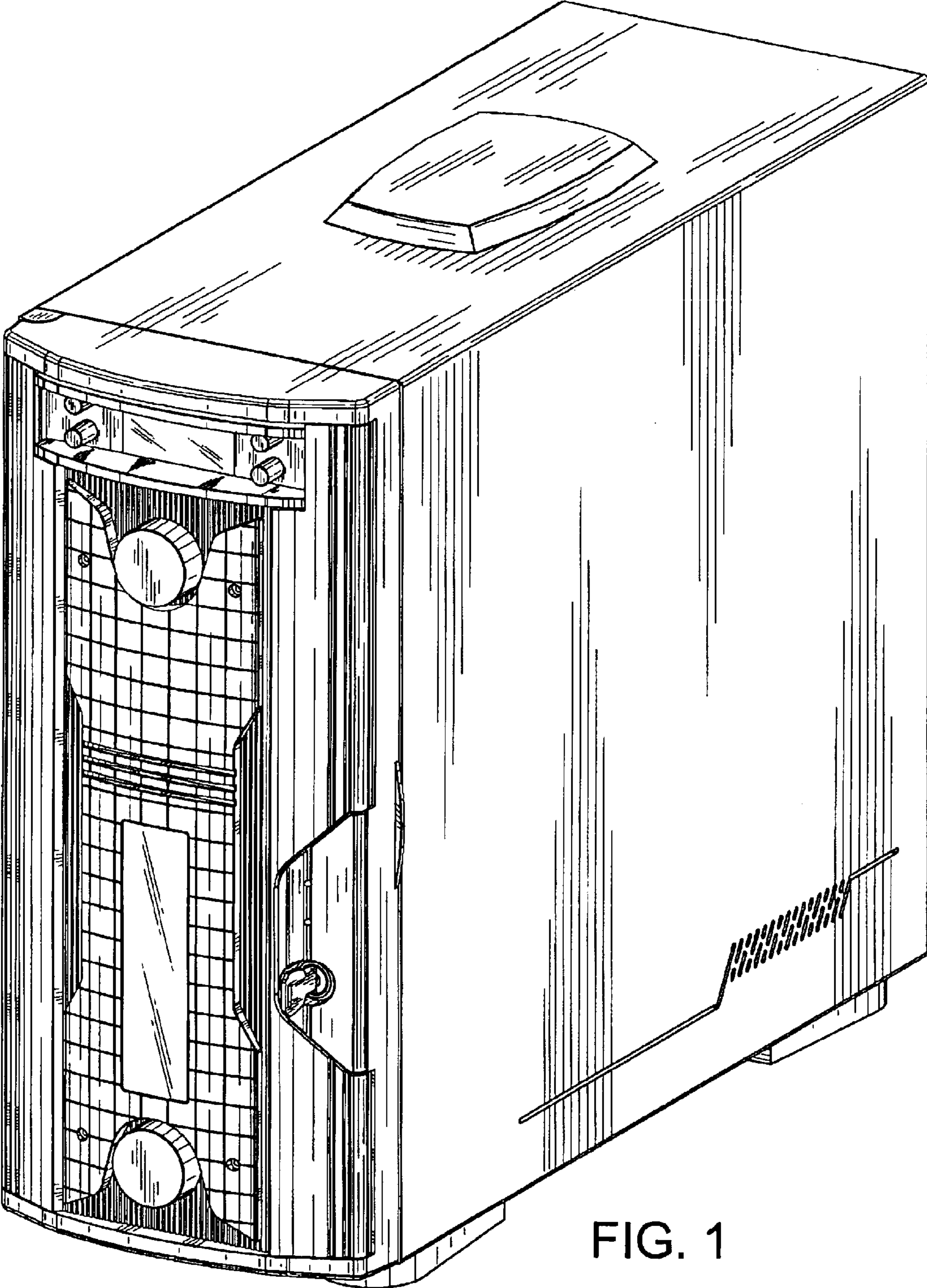


FIG. 1

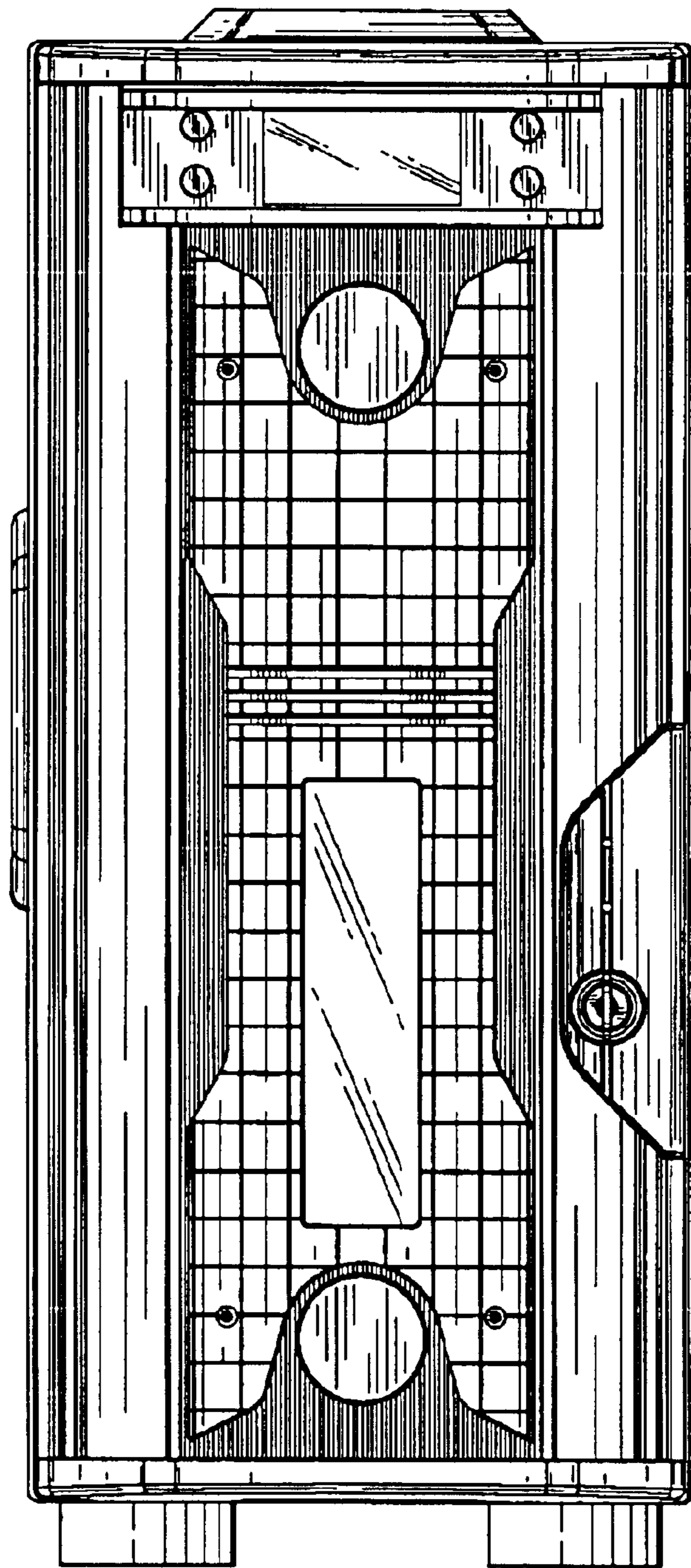


FIG. 2

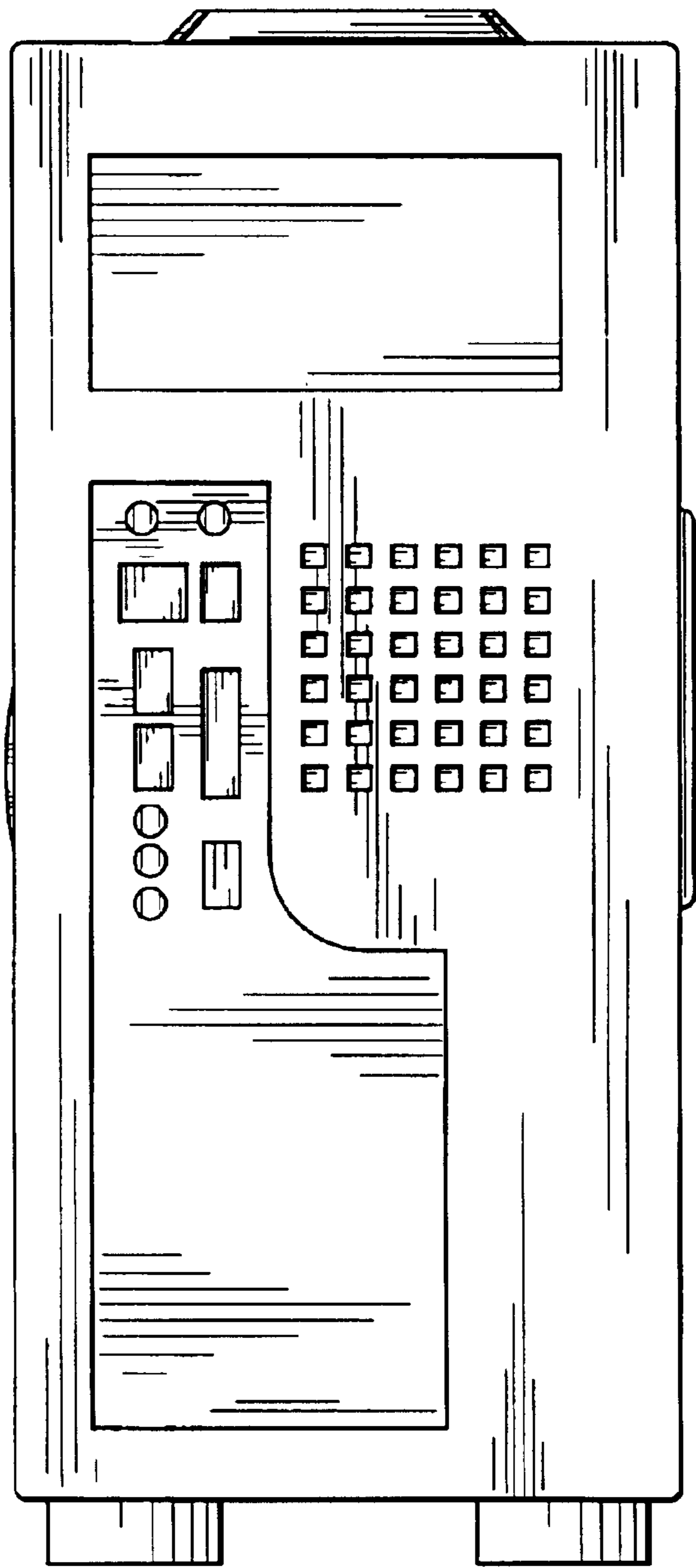
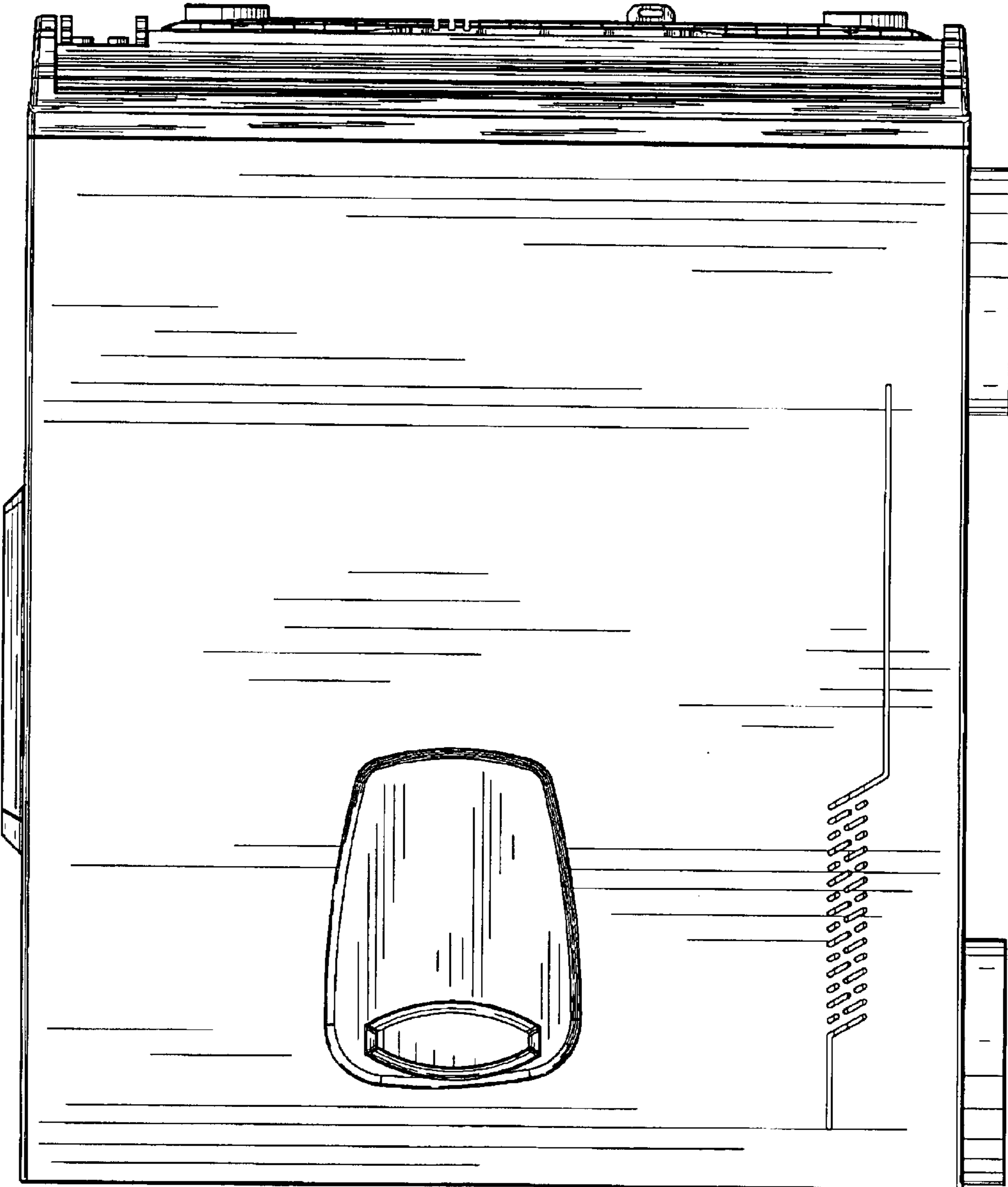


FIG. 3

FIG. 4



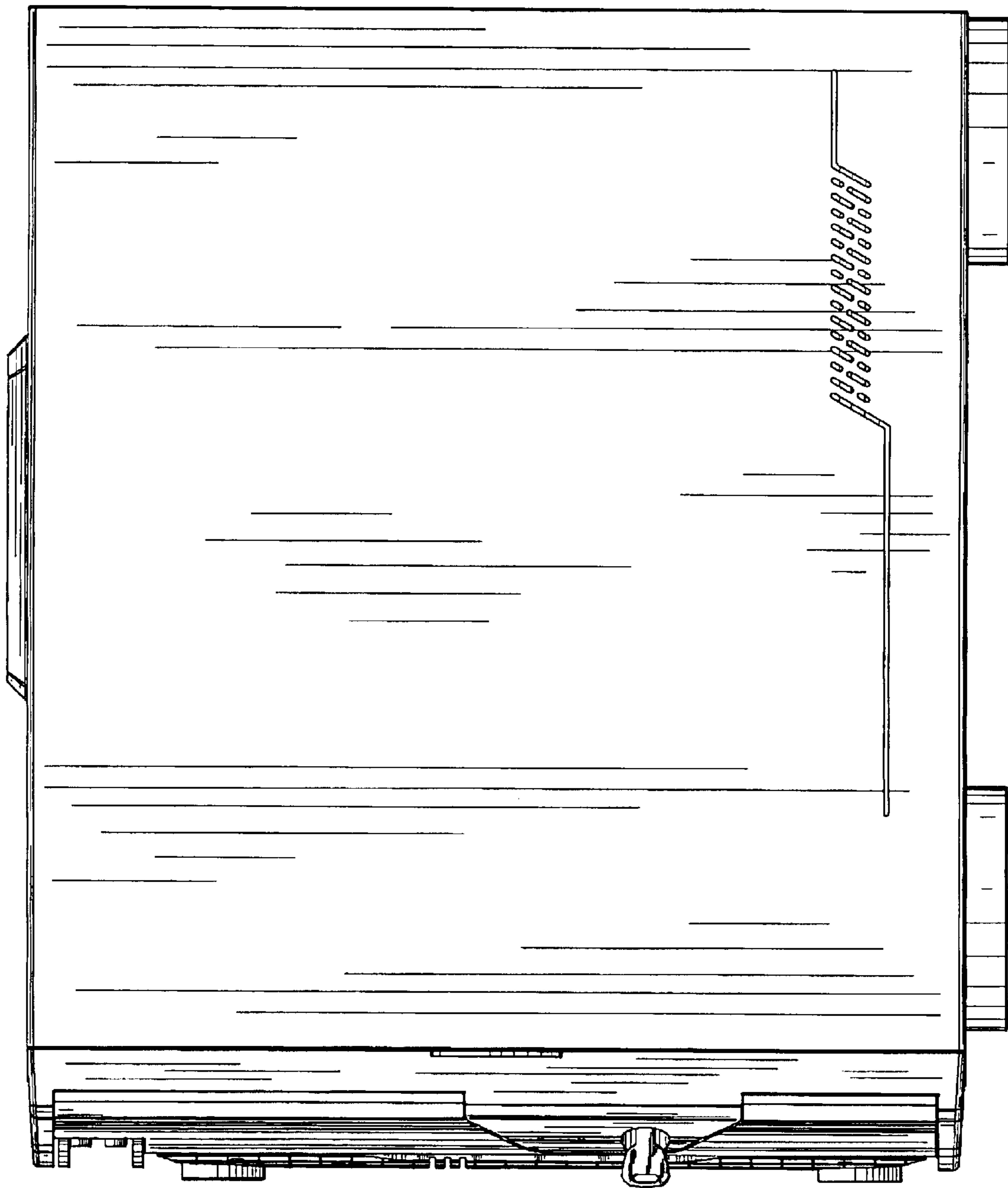


FIG. 5

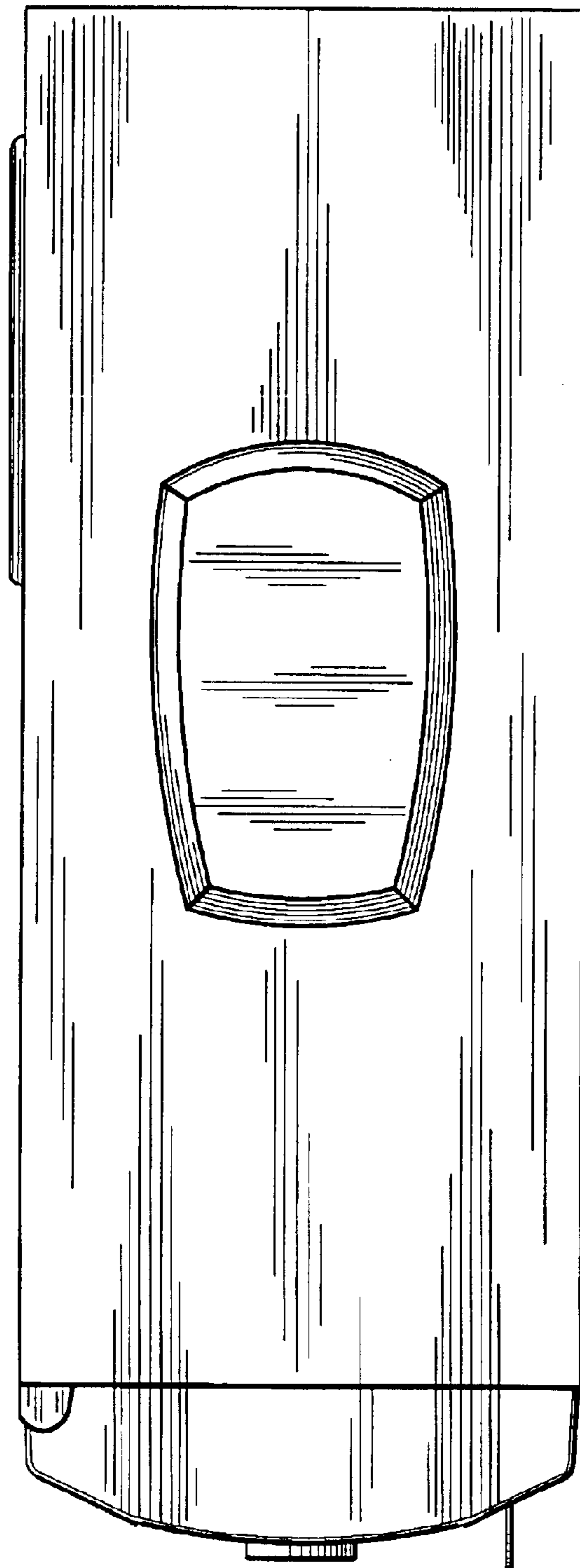


FIG. 6

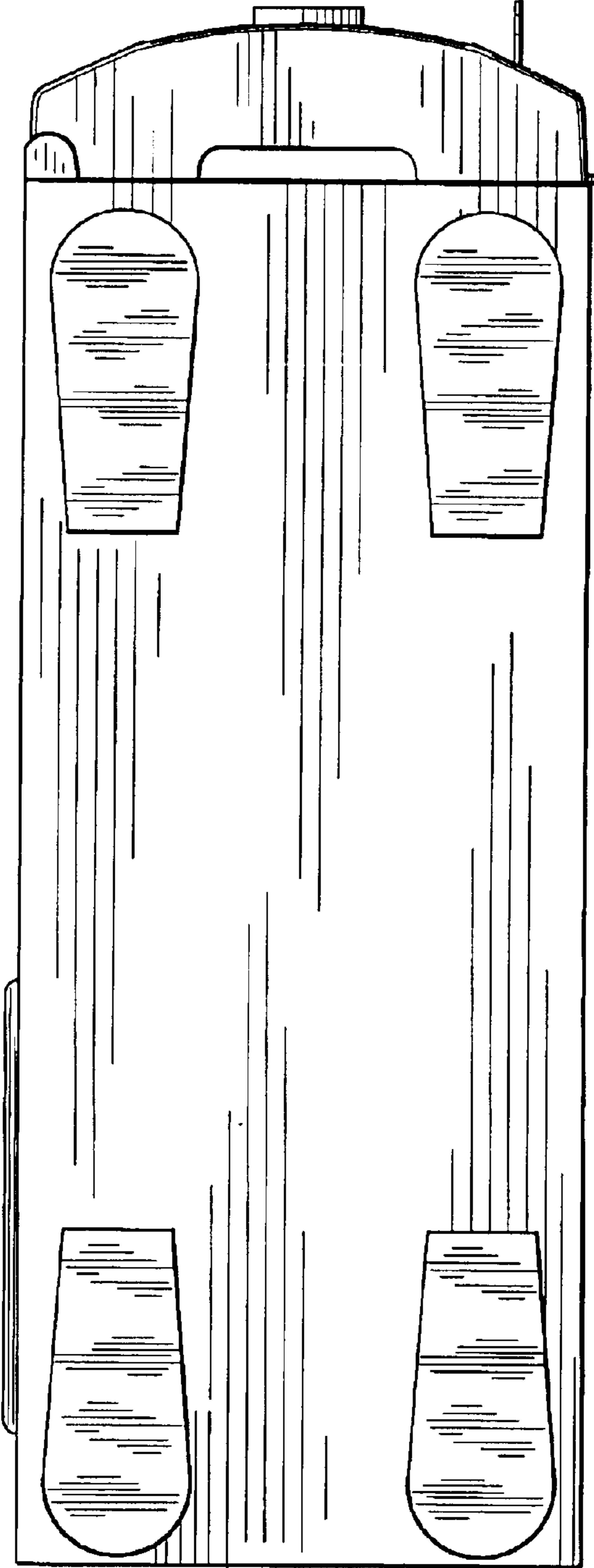


FIG. 7

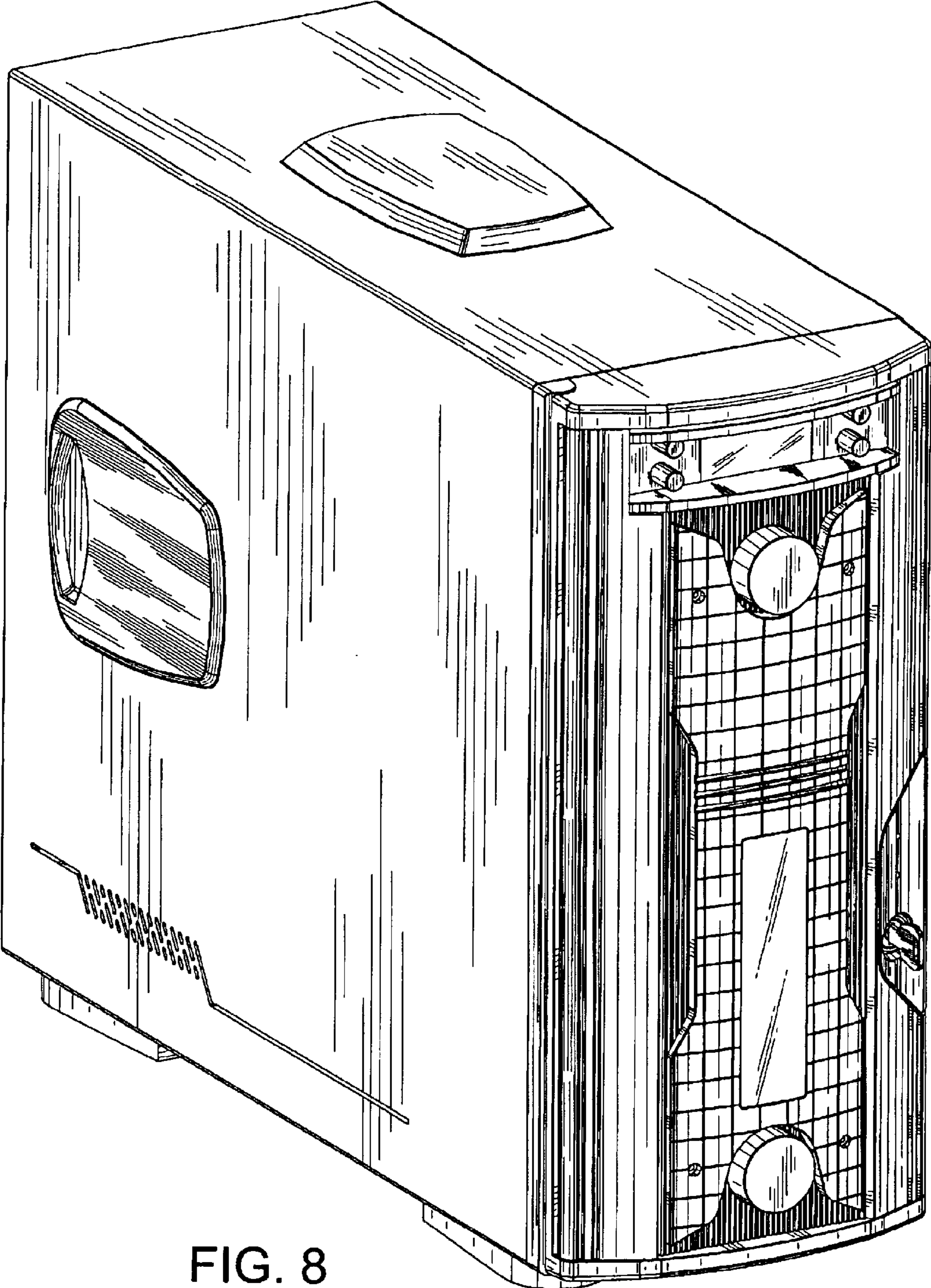


FIG. 8